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# FORESEE® Shit C'

# 1.Gbit SLC NAND Flash

**Datasheet** 

LM-00003

Rev 1.3

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### **Revision History**

Rev.	Date	Changes	19At!
1.0	2020/01/28	Initial release	10
1.1	2021/10/12	Revise descriptions in 10.1, 10.4, 10.6.2, 10.6.3, 12.5	
1.2	2021/11/22	Revise descriptions in 4, 14.1, 14.2	
1.3	2021/12/3	Add Chap 15	

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### **General Description** 1

The FSNU8A001G is a 1G-bit (128Mx8bit) NAND Flash Memory with spare 32M-bit. The device on a single 1.8V VCC. A program operation can be performed in typical 350µs on the (2K+64) Byte page and an erase operation can be performed in typical 2ms on a (128K+4K) Byte block. Data in the page buffer can be read out at 25ns cycle time per Byte. The FSNU8A001G is an optimum solution for large nonvolatile storage applications such as solid state file storage and other portable applications requiring non-volatility.

The FSNU8A001G supports the standard NAND flash memory interface using the multiplexed 8-bit bus to transfer data, addresses, and command instructions. The five control signals, CLE, ALE, CE#, RE# and WE# handle the bus interface protocol. Also, the device has two other signal pins, the WP# and the R/B# for monitoring the device status.

### **Features**

### **Voltage Supply**

- VCC: 1.7V ~ 1.95V

### **Organization**

- Memory Cell Array: (128M + 4M) Byte

- Page Size: (2k + 64) Byte

- Block Size: 64 pages, (128k + 4k) Byte

- Plane Size: 1,024 Blocks

### High Performance

- Random Read: 25µs Sequential Read: 25ns

- Page Program Time: 350µs (Typ.)

- Block Erase Time: 2ms (Typ.)

### **Low Power**

- Standby: 10µA (Typ.)

- Read: 10mA (Typ.)

2022-07-25 10:0 - Program/Erase: 15mA (Typ.)

### **Advanced Features**

- .cut A8D12C1BB012A - Hardware WP# write protect
- Software block protect
- Unique ID
- One 2kB parameter page
- Sixty-two 2kB OTP Pages
- Promised golden block0

### **High Reliability**

- Endurance: typical 100k cycles (1)

- Data Retention: 10 years (1)

### **Package**

- 48-TSOP

- 63-TFBGA (11x9mm)

### Note:

(1) Endurance and Data Retention specification is based on

1bit / 528Byte ECC

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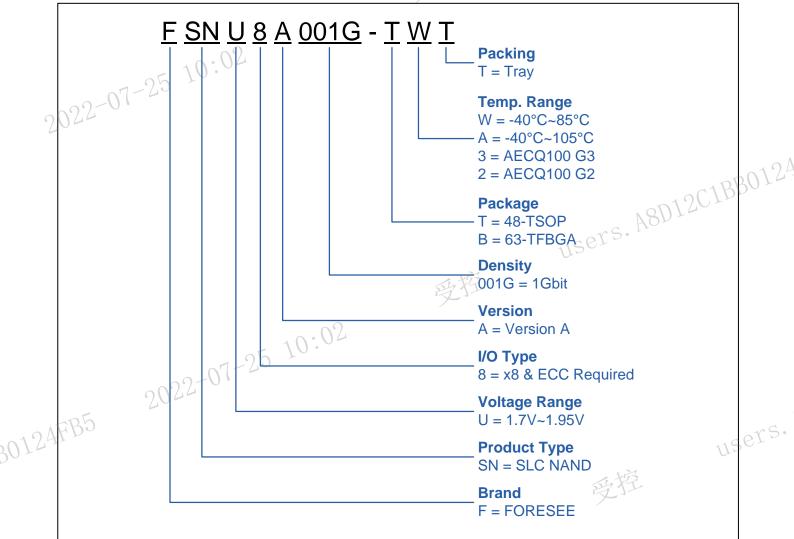


### 3 Product List

**Table 1 Product List** 

Part Number	Density	I/O Type	Voltage Range	Package	Temp. Range	Packing
FSNU8A001G-TWT	1Gb	x8	1.7V ~ 1.95V	48-TSOP	-40°C ~ 85°C	Tray
FSNU8A001G-TAT	1Gb	х8	1.7V ~ 1.95V	48-TSOP	-40°C ~ 105°C	Tray
FSNU8A001G-BWT	1Gb	x8	1.7V ~ 1.95V	63-TFBGA	-40°C ~ 85°C	Tray
FSNU8A001G-BAT	1Gb	x8	1.7V ~ 1.95V	63-TFBGA US	-40°C ~ 105°C	Tray

Figure 1 Marketing Part Numbering Chart



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### **Package Types and Pin Configurations**

Figure 2 Pin Configuration 48-TSOP

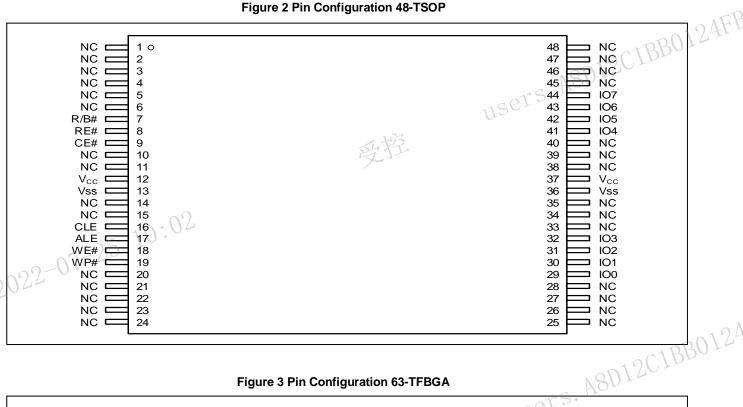
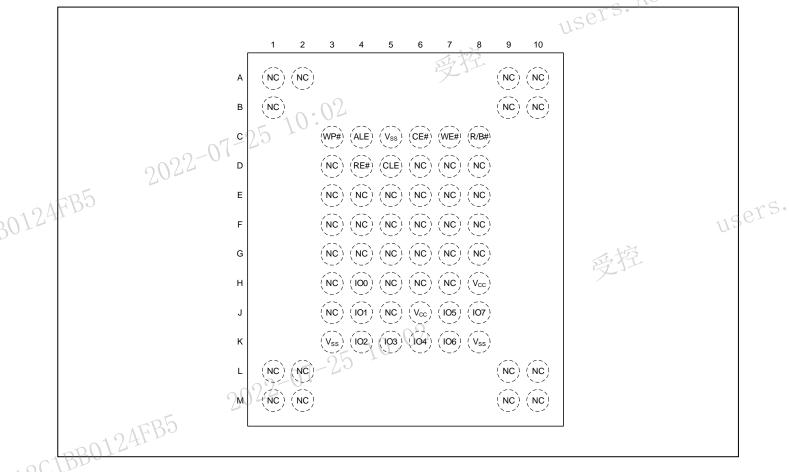


Figure 3 Pin Configuration 63-TFBGA



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### **Pin Descriptions** 5

**Table 2 Pin Description** 

	Table 2 Pin Description
Pin Name	Pin Functions Pin Functions
	Chip Enable
CE#	The CE# input is the device selection control. When the device is in the Busy state, CE# high is ignored, and the
	device does not return to standby mode in program or erase operation.
	Read Enable
RE#	The RE# input is the serial data-out control, and when active drives the data onto the I/O bus. Data is valid t <sub>REA</sub>
	after the falling edge of RE# which also increments the internal column address counter by one.
	Write Enable
WE#	The WE# input controls writes to the I/O port. Commands, address and data are latched on the rising edge of
- 07	the WE# pulse.
022	Command Latch Enable
CLE	The CLE input controls the activating path for commands sent to the command register. Commands are
	latched on the rising edge of WE# with CLE high.
	Address Latch Enable
ALE	The ALE input controls the activating path for address sent to the address registers. Addresses are latched on
	the rising edge of WE# with ALE high.
	Write Protect
WP#	The WP# input can be used to prevent the inadvertent program / erase to the device. All program / erase
	operations are disabled when WP# is active low.
	Ready / Busy Output
D/D#	The R/B# output indicates the status of the device operation. When low, it indicates that a program, erase or
R/B#	random read operation is in process and returns to high state upon completion. It is an open drain output and
	does not float to high-z condition when the chip is deselected or when outputs are disabled.
	Data Inputs / Outputs
107 - 100	The IO pins are used to input command, address and data and to output data during read operations. The IO
EBO	pins float to high-z when the chip is deselected or when the outputs are disabled.
VSS	Ground

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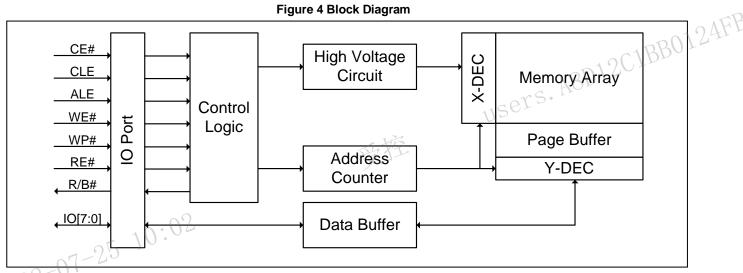
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### **Block Diagram**

Figure 4 Block Diagram



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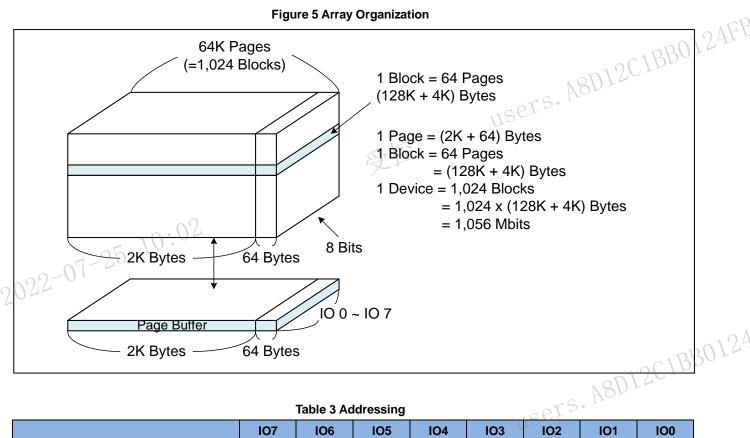
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### **Array Organization and Mapping**

Figure 5 Array Organization



**Table 3 Addressing** 

		107	106	105	104	103	102	IO1	100
Column Address	1st cycle	A7	A6	A5	A4	A3	A2	A1	A0
	2nd cycle	L	L	L'Z	L	A11	A10	A9	A8
Row Address	3rd cycle	A19	A18	A17	A16	A15	A14	A13	A12
	4th cycle	\ A27	A26	A25	A24	A23	A22	A21	A20

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### Note

- (1) L: A low condition, which must be held during the address cycle to insure correct processing.
- (2) A17~A12 are page addresses, A27~A18 are block addresses.

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### **Mode Selection**

### **Table 4 Mode Selection**

		Table	4 Mode Selec	ction				
	Mode		ALE	CE#	WE#	RE#	WP#	(2At 1
Read	Command Input	Н	L	L		Н	0018BU	10
Reau	Address Input (4 cycles)	L	Н	L		401	X	
Write	Command Input	Н	L	L	LF	s. H	Н	
vviite	Address Input (4 cycles)	L	Н	L	T. A.	Н	Н	
	Data Input		L	With L		Н	Н	
	Data Output	L	L发	17 L	Н	7	Х	
D	uring Read (Busy)	Х	Х	Х	Х	Н	Х	
Dur	ring Program (Busy)	Х	Х	Х	Х	Х	Н	
Di	During Erase (Busy)		Х	Х	Х	Х	Н	
	Write Protect		Х	Х	Х	Х	L	
02-0	Stand-by	Х	Х	Н	Х	Х	0V / V <sub>CC</sub>	]

Note

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<sup>(1) &</sup>quot;H" indicates a HIGH input level, "L" indicates a LOW input level, and "X" can be  $V_{IL}$  or  $V_{IH}$ . users. A8D12C1BB012A



### **Command Set**

**Table 5 Command Table** 

	Table 5 Command	Table		1
Command	1 <sup>st</sup> Cycle	2 <sup>nd</sup> Cycle	Acceptable While Busy	(24F)
Reset	FFh	-	Yes 1880	10
Page Read	00h	30h	1801201	
Random Data Output	05h	E0h	S. Aus	
Read Status	70h	- 11563	Yes	
Read ID	90h	-		
Read Parameter Page	ECh	<u> </u>		
Read Unique ID	EDh	-		
Page Program	80h	10h		
Random Data Input	85h	-		
Copy Back Read	00h	35h		
Copy Back Program	85h	10h		
Block Erase	60h	D0h		
Get Feature	EEh	-		
Set Feature	EFh	-		-194
Note  (1) Random Data Input and Random Data  (2) Any commands not in the above table a	•	be used within a page. If and are prohibited as input	s. ASD12C1B	B012

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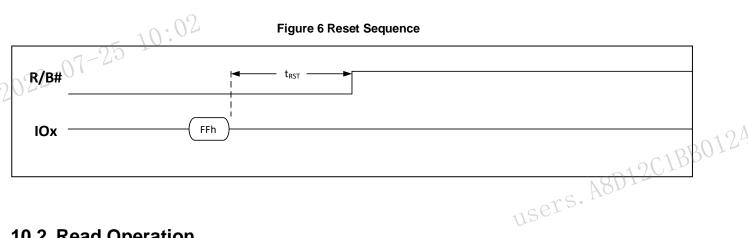


### **Device Operation**

### 10.1 Reset (FFh)

,0124FB The device offers a reset operation, executed by writing FFh to the command register. When the device is in busy state during random read, program or erase mode, the reset operation will abort these operations. The contents of memory cells being altered are no longer valid, as the data will be partially programmed or erased. The command register is cleared to wait for the next command, and the Status Register is cleared to value C0h when WP# is high. If the device is already in Ready state, a new reset command will be accepted by the command register, and the device is reset instantly, but the R/B# pin will not change to low.

Figure 6 Reset Sequence



### 10.2 Read Operation

### 10.2.1 Page Read (00h-30h)

The FSNU8A001G array is accessed in page of 2,112 bytes. When the device powers on, 00h command is latched to command register. Therefore, system only issues four address cycles and 30h command for initial read from the device. This operation can also be entered by writing 00h command to the command register, and then write four address cycles, followed by writing 30h command. After writing 30h command, the data is transferred from NAND array to page buffer during t<sub>R</sub>.

Data transfer progress can be done by monitoring the status of the R/B# signal output. R/B# signal will be LOW during data transfer. Also, there is an alternate method by using the Read Status command. If the Read Status command is issued during read operation, the Page Read command must be re-issued to read out the data from page buffer.

Once the data in a page is loaded into the page buffer, R/B# signal goes high, and the data can be read from Page buffer by toggling RE#. Read is sequential from initial column address to the end of the page.

If the host side uses a sequential access time (t<sub>RC</sub>) of less than 30ns, the data can be latched on the next falling edge of RE# as the waveform of EDO mode.



The device may output random data in a page instead of the consecutive sequential data by writing Random Data Output command. The column address of next data, which is going to be out, may be changed to the address which follows random data output command. Random data output can be operated multiple times regardless of how many times it is done in a page.

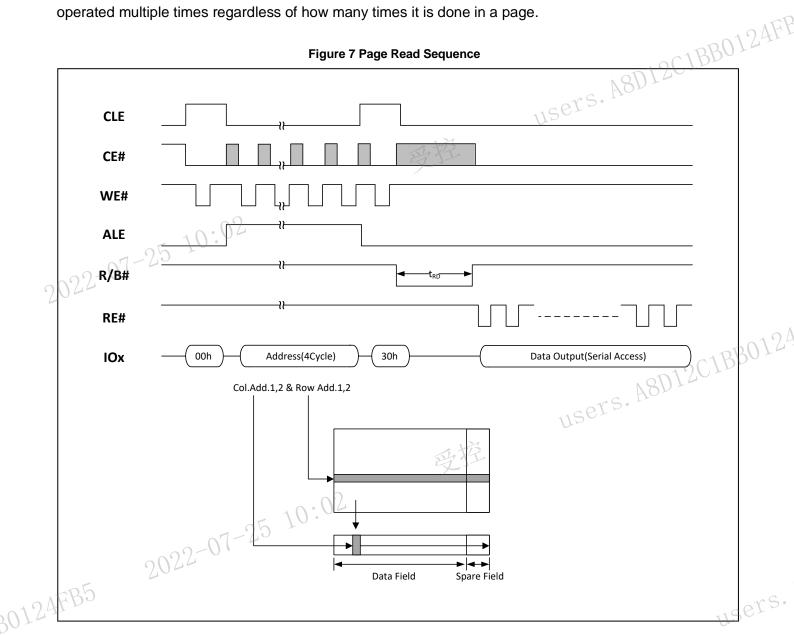


Figure 7 Page Read Sequence

### 10.2.2 Random Data Output (05h-E0h)

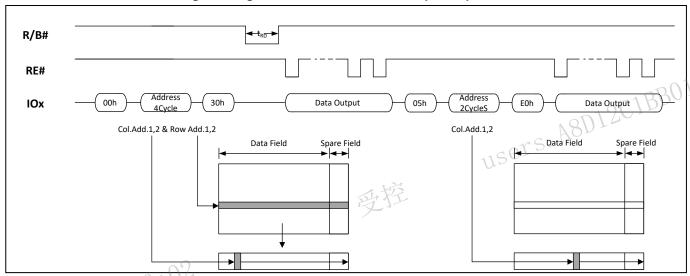
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The Random Data Output command allows the selection of random column addresses to read out data from a single or multiple of addresses. The use of the Random Data Output command is available after the Page Read (00h-30h) sequence by writing the 05h command following by the two cycle column address and then the E0h command. Toggling RE# will output data sequentially. The Random Data Output command can be issued multiple times, but limited to the current loaded page.

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Figure 8 Page Read with Random Data Output Sequence



### 10.2.3 Read Status (70h)

The device contains a Status Register which may be read to find out whether program or erase operation is completed, and whether the program or erase operation is completed successfully. After writing 70h command to the command register, a read cycle outputs the content of the Status Register to the I/O pins on the falling edge of CE# or RE#, whichever occurs last. This two line control allows the system to poll the progress of each device in multiple memory connections even when R/B pins are common-wired. RE# or CE# does not need to be toggled for updated status. Refer to Table 6 for specific Status Register definitions.

The command register remains in Read Status mode until another command is issued. Therefore, if the status register is read during a random read cycle, the Page Read command should be given before starting read cycles.

30124FB5 users. **CLE** tCEA tCHZ CE# tWP ţCOḤ WE# tRHZ tRHOH RE# tREA Status Output **IOx** 

Figure 9 Read Status Sequence

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Table 6	<b>Status</b>	Register	Definition
---------	---------------	----------	------------

SR Bits	Page Program	Block Erase	Read	Definition				
IO 0	Pass / Fail	Pass / Fail	Not use	0 = Pass, 1 = Fail				
IO 1	Not use	Not use	Not use	Don't -care				
IO 2	Not use	Not use	Not use	Don't -care				
IO 3	Not use	Not use	Not use	Don't -care				
IO 4	Not use	Not use	Not use	Don't -care				
IO 5	Not Use	Not Use	Not Use	Don't -care				
IO 6	Ready / Busy	Ready / Busy	Ready/Busy	0 = Busy, 1 = Ready				
IO 7	Write Protect	Write Protect	Write Protect	0 = Protected, 1 = Unprotected				

Note

(1) IOs defined 'Not use' are recommended to be masked out when Read Status is being executed.

## 10.2.4 Read ID (90h).

Read ID command is comprised of two modes determined by the input address, device (00h) or ONFI (20h) identification information. To enter the Read ID mode, write 90h command following by a 00h address cycle, then toggle RE# for 5 single byte cycles. The pre-programmed code includes the Manufacturer ID, Device ID, and Product-Specific Information (See Table 8). If the Read ID command is followed by 20h address, the output code includes 4 single byte cycles of ONFI identifying information. The device remains in the Read ID mode until the next valid command is issued.

Figure 10 Read ID Sequence

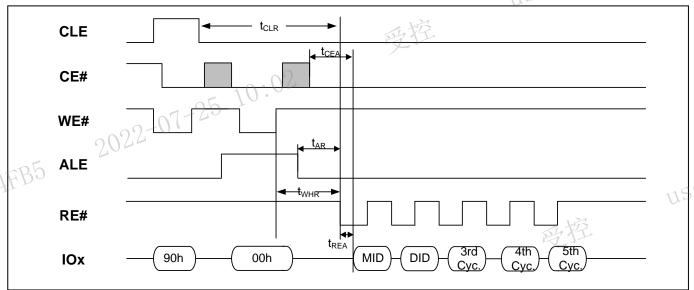


Table 7 Device and ONFI identification information

Addres	s	1 <sup>st</sup> Byte/Cycle	2 <sup>nd</sup> Byte/Cycle	3 <sup>rd</sup> Byte/Cycle	4 <sup>th</sup> Byte/Cycle	5 <sup>th</sup> Byte/Cycle
00h		CDh 22	A1h	00h	95h	40h
Oon	00h	Manufacturer ID	Device ID	0011	9311	4011
20h	Th De	4Fh	4Eh	46h	49h	-
12C1BB01						
Frankhina for	r Mamar		16	/ 50		Langerya Convisio



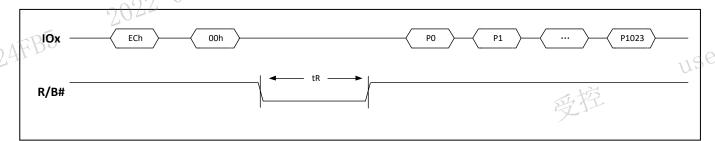
### **Table 8 Product-Specific Information**

Terms	Description	107	106	105	104	103	102	IO1	100	
3 <sup>rd</sup> Byte			00h							
Cache Program	0 = Not supported	0								
Multiple die operation	0 = Not supported		0						20	
Simultaneously Programmed page number	00 = 1			0	0		181	12C	BBC	
Cell type	00 = SLC					0,5	0			
Die number per CE	00 = 1				U	50		0	0	
4 <sup>th</sup> Byte			1.4%	1	9	5h				
Sequential access min	10 = 25ns	1	支小			0				
Organization	0 = x8		0							
Block size (without spare)	01 = 128kB			0	1					
Spare size per 512B	1 = 16						1			
Page size	01 = 2kB							0	1	
5 <sup>th</sup> Byte		40h								
Internal ECC	0 = Not supported	0								
Plane size	100 = 1Gb		1	0	0					
Plane number per CE	00 = 1					0	0			
ECC requirement	00 = 1bit / 528B							0	- OP	
10.2.5 Read Parameter Page (ECh)										

### 10.2.5 Read Parameter Page (ECh)

Read Parameter Page can read out the device's parameter data structure, such as, manufacturer information, device organization, timing parameters, key features, and other pertinent device parameters. The data structure is stored with at least three copies in the device's parameter page. The Random Data Output command is supported during data output.

Figure 11 Read Parameter Page Sequence



**Table 9 Parameter Definition** 

		711.5	
Byte	Number	Descriptions	Values
(	0~3	Parameter Page Signature, "ONFI" ASCII characters	4Fh 4Eh 46h 49h
4	4~5	Revision Number	02h 00h
12C1BB0	124FB		
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Byte Number	Descriptions	Values			
	Feature Supported				
	b6-b15 reserved (0)				
	b5 1 = supports source synchronous				
6.7	b4 1 = supports odd to even page Copyback	40k 00k			
6~7	b3 1 = supports interleaved operations	10h 00h			
	b2 1 = supports non-sequential page programming	1801201			
	b1 1 = supports multiple LUN operations	ers. Aor			
	b0 1 = supports 16-bit data bus width	10h 00h  USers. A8D12CIBBC			
	Optional Command Supported				
	b6-b15 reserved (0)				
	b5 1 = supports Read Unique ID				
0.0	b4 1 = supports Copy-back	0.41 0.01			
8~9	b3 1 = supports Read Status Enhanced	34h 00h			
	b2 1 = supports Get Features and Set Features				
07-20	b1 1 = supports Read Cache commands				
022-01	b0 1 = supports Page Cache Program command				
10~31	Reserved (0)	all 00h			
		46h 4Fh 52h 45h			
32~43	Device manufacturer , 12 ASCII characters	53h 45h 45h 20h			
		20h 20h 20h 20h			
		46h 53h 4Eh 55h			
		38h 41h 30h 30h			
44-63	Device Model, 20 ASCII characters	31h 47h 20h 20h			
	20h 20h 20h 20h				
	7	20h 20h 20h 20h			
64	JEDEC MID	CDh			
65-66	Date Code 1000	00h 00h			
67-79	Reserved (0)	all 00h			
80-83	Number of Data Bytes per Page	00h 08h 00h 00h			
84-85	Number of Spare Bytes per Page	40h 00h			
FB <sup>3</sup> 86-89	Number of Data Bytes per Partial Page	00h 02h 00h 00h			
90-91	Number of Spare Bytes per Partial Page	10h 00h			
92-95	Number of Pages per Block	40h 00h 00h 00h			
96-99	Number of Block per Logic Unit	00h 04h 00h 00h			
100	Number of Logic Units	01h			
	Number of Address Bytes				
101	b4-b7 column address cycles	22h			
	b4-b7 column address cycles b0-b3 row address cycles				
102	Number of Bits per Cell	01h			
103-104	Bad Blocks Maximum per Logic Unit	14h 00h			
105-106	Block Endurance	01h 05h			
- A A - D					
107	Guaranteed Valid Blocks at Beginning of Target	01h			
108-109	Block Endurance for Guaranteed Valid Blocks	01h 03h			

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Byte Number	Descriptions	Values
110	Number of Programs per Page	04h
	Partial Programming Attributes	
	b5-b7 reserved (0)	
444	b4 1 = partial page layout is partial page data	006
111	followed by partial page spare	00h
	b1-b3 reserved (0)	(8D12011
	b0 1 = partial page programming has constraints	ooh online ABD12C1BB0
112	Number of ECC Bits Correctability	01h).S
	Number of Interleaved Address Bits	
113	b4-b7 reserved (0)	00h
	b0-b3 number of interleaved address bits	
	Interleaved Operation Attributes	
	b4-b7 reserved (0)	
05	b3 address restrictions for program cache	
114 - 2	b2 1 = program cache supported	00h
114, -25	b1 1 = no block address restrictions	
	b0 overlapped / concurrent interleaving support	
115-127	Reserved (0)	all 00h
128	I/O Pin Capacitance, Maximum	08h
	Asynchronous Timing Mode Support	users. A8D12C1B
	b6-b15 reserved (0)	A8012
	b5 1 = supports timing mode 5	users.
400 400	b4 1 = supports timing mode 4	451 001
129-130	b3 1 = supports timing mode 3	1Fh 00h
	b2 1 = supports timing mode 2	
	b1 1 = supports timing mode 1	
	b0 1 = supports timing mode 0, shall be 1	
	Asynchronous Program Cache Timing Mode Support	
00	b6-b15 reserved (0)	
4	b5 1 = supports timing mode 5	
FBO	b4 1 = supports timing mode 4	201-201-
131-132	b3 1 = supports timing mode 3	00h 00h
	b2 1 = supports timing mode 2	
	b1 1 = supports timing mode 1	受红
	b0 1 = supports timing mode 0, shall be 1	
133-134	t <sub>PROG</sub> Maximum Page Program Time (us)	BCh 02h
135-136	t <sub>BER</sub> Maximum Block Erase Time (us)	10h 27h
137-138	t <sub>R</sub> Maximum Page read Time (us)	19h 00h
139~140	t <sub>CCS</sub> Minimum Change Column Setup Time (ns)	3Ch 00h
141-163	Reserved (0)	all 00h
164-165	Vendor Specific Revision Number	00h 00h
166-253	Vendor Specific	all 00h
254-255	Integrity CRC	20h 47h
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Byte Number	Descriptions	Values
256-511	Value of Bytes 0-255	
512-767	Value of Bytes 0-255	
768+	Additional Redundant Parameter Pages	

### Note:

(1) The Integrity CRC (Cycling Redundancy Check) field is used to verify that the contents of the parameters page were transferred correctly to the host. Please refer to ONFI 1.0 specifications for details. The CRC shall be calculated using the users. following 16-bit generator polynomial: G(X) = X16 + X15 + X2 + 1

### 10.2.6 Read Unique ID (EDH)

The unique ID is 32-byte and with 16 copies for back-up purpose. After writing the Unique ID read command and following the one address byte (00h), the host may read out the unique ID data. The host need to XOR the 1st 16-byte unique data and the 2nd 16-byte complement data to get the result, if the result is FFh, the unique ID data is correct; otherwise, host need to repeat the XOR with the next copy of Unique ID data.

Once sending the EDh command, the NAND device will remain in the Unique ID read mode until next valid command is sent. The Random Data Output command is supported during data output.

The Read Status command can be used to check the completion. To continue the read operation, a following read command (00h) to re-enable the data out is peoperate. users. A81

Figure 12 Read Unique ID Sequence

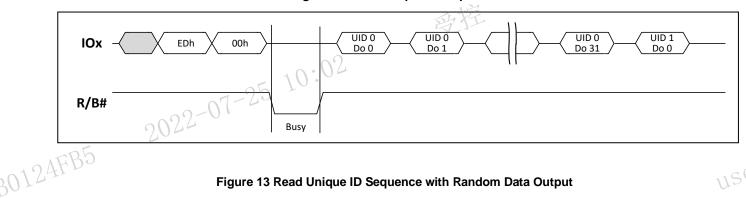
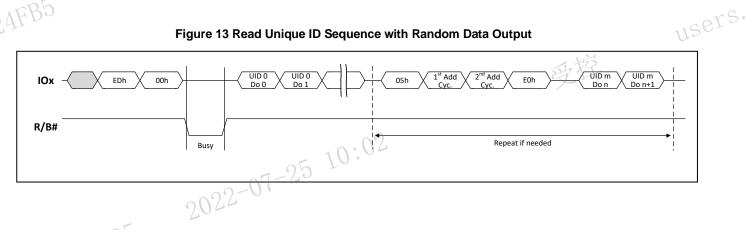


Figure 13 Read Unique ID Sequence with Random Data Output



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### **10.3 Program Operation**

### 10.3.1 Page Program (80h-10h)

The device is programmed basically on a page basis, but it does allow multiple partial page programming of a word or consecutive bytes up to 2,112 in a single page program cycle. The number of consecutive partial page programming operation within the same page without an intervening erase operation must NOT exceed 4 times for a single page. The addressing should be done in sequential order in a block.

A page program cycle consist of a serial data loading period in which up to 2,112-bytes of data may be loaded into the page buffer, followed by a non-volatile programming period where the loaded data is programmed into the appropriate cell.

The serial data loading period begins by inputting the 80h command, followed by the four cycle address inputs and then serial data loading. The words other than those to be programmed do not need to be loaded. The 10h command initiates the programming process. Writing 10h alone without previously entering the serial data will not initiate the programming process.

The internal write state controller automatically exe-cutes the algorithms and timings necessary for program and verify, thereby freeing the system controller for other tasks. Once the program process starts, the Read Status command may be entered to read the status register. The system controller can detect the completion of a program cycle by monitoring the R/B# output, or the Status bit (IO6) of the Status Register. Only the Read Status command and Reset command are valid while programming is in progress. When the Page Program is complete, the Write Status bit (IO 0) may be checked (See Figure 14). The internal write verify detects only errors for "1"s that are not successfully programmed to "0"s. The command register remains in Read Status command mode until another valid command is written to the command register.

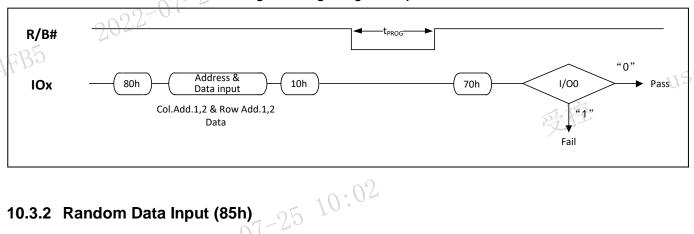


Figure 14 Page Program Sequence

### 10.3.2 Random Data Input (85h)

After the Page Program 80h command execution of the initial data has been loaded into the page buffer, if the need for additional writing of data is required, using the Random Data Input command can perform this function to a new column address prior to the 10h command. The Random Data Input may be operated multiple times regardless of how many times it is done in a page.



R/B#

IOx

80h

Address & Data input

Col.Add.1,2 & Row Add.1,2
Data

Data

Data

Data

Data

Data

Data

Data

Data

Figure 15 Page Program with Random Data Input Seguence

### 10.4 Copy Back Operation

Copy Back operations can quickly and efficiently rewrite data stored in one page. The benefit is especially obvious when a portion of a block is updated and the rest of the block also needs to be copied to the newly assigned free block. The operations require two sequential command sets. Issue a Copy Back Read command first, then the Copy Back Program command.

Since Copy Back operations do not use external memory and the data of source page might include a bit errors, a competent ECC scheme should be developed to check the data before programming data to a new destination page.

Note: Copy Back Operation can only be used to copy even page to even page or to copy odd page to odd page.

### 10.4.1 Copy Back Read (00h-35h)

The Copy Back Read command is used together with the Copy Back Program command. To start execution, 00h command is written to the command register, followed by the four cycles of the source page address. To start the transfer of the selected page data from the memory array to the page buffer, write the 35h command to the command register.

After execution of the Copy Back Read command sequence and R/B# returns to HIGH marking the completion of the operation, the transferred data from the source page into the page buffer may be read out by toggling RE#. Data is output sequentially from the column address that was originally specified with the Copy Back Read command (See **Figure 16**).

The Random Data Output commands can be issued multiple times without any limitation after Copy Back Read command has been executed.

### 10.4.2 Copy Back Program (85h-10h)

After the Copy Back Read command operation has been completed and R/B# goes HIGH, the Copy Back Program command can be written to the Command Register.

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The operation is initiated by issuing 85h command with destination page address. Actual programming operation begins after 10h command is issued. Once the program process starts, the Read Status command may be entered to read the status register. The system controller can detect the completion of a program cycle by monitoring the R/B# output, or the Status bit (IO6) of the Status Register. When the copy back program is complete, the Write Status Bit (IO0) may be checked (See **Figure 16**). The command register remains in Read Status command mode until another valid command is written to the command register.

During copy-back program, data modification is possible using Random Data Input command with multiple times (see **Figure 17**).

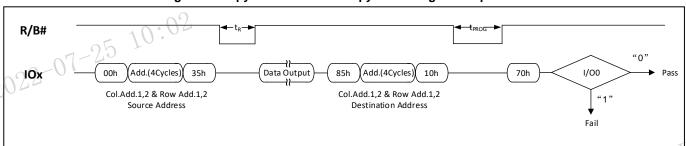
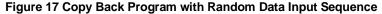
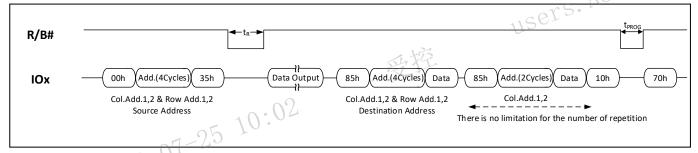


Figure 16 Copy Back Read and Copy Back Program Sequence





### 10.5 Block Erase (60h-D0h)

The erase operation is done on a block basis. Block address loading is accomplished in two cycles initiated by 60h command. Only address A18 to A27 is valid while A12 to A17 is ignored. The D0h command following the block address loading initiates the internal erasing process. This two-step sequence of setup followed by execution command ensures that memory contents are not accidentally erased due to external noise conditions.

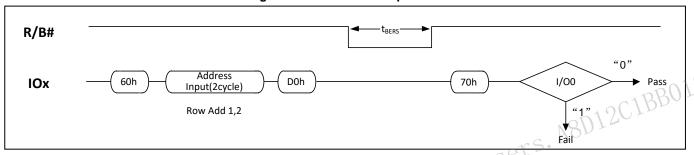
At the rising edge of WE# after the erase confirm command input, the internal write controller handles erase and erase-verify. The system controller can detect the completion of an erase cycle by monitoring the R/B# output, or the Status bit (IO6) of the Status Register. When the block erase operation is complete, the Write Status Bit (IO0) may be checked.

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user



### Figure 18 Block Erase Sequence



### **10.6 Feature Operation**

The Feature Set operation is to change the default power-on feature sets by using the Set Feature and Get Feature command and writing the specific parameter data (P1-P4) on the specific feature addresses. The NAND device may remain the current feature set until next power cycle since the feature set data is volatile. However, the Reset command cannot reset the current feature set.

### 10.6.1 Feature Register

**Table 10 Feature Register** 

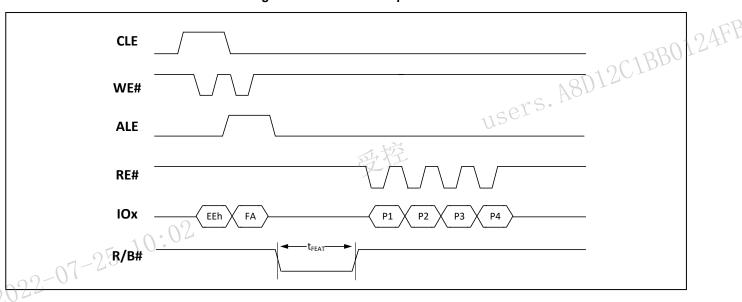
Table 10 Feature Register									012								
Feature Register	Address	Parameter	107	106	105	104	103	102	IO1	100	Description	)0 -					
			0	0	0	0	0	0	0	0 1	Normal Mode, default value after power cycle.						
		P1	0	0	0	0	0	挖	0	1	OTP Operation Mode. See 10.7.1 for detail information						
Operation Mode	90h		0 (	.02	0	0	0	0	1	1	OTP Lock Mode. See 10.7.2 for detail information						
							P2-20	1			Reserv	ved (0)					
		P3	Reserved (0)														
		P4		Reserved (0)													
Block Protection	A0h	P1	R	BP3	BP2	BP1	BP0	ТВ	0	SP	Default value after power cycle is 00000000 (00h).  See 10.8 for detail information	ers					
		P2		ı	I.	Reserv	ved (0)	I.	I.								
		P3				Reserv	ved (0)										
		P4		Reserved (0)													

10.6.2 Get Feature (EEh) The Get Feature command is to read feature parameter. After sending the Get Feature command and following register address, the host may read out the P1-P4 sub-feature parameter data. Once sending the EEh command, the NAND device will remain in the Get Feature mode until next valid command is



sent.



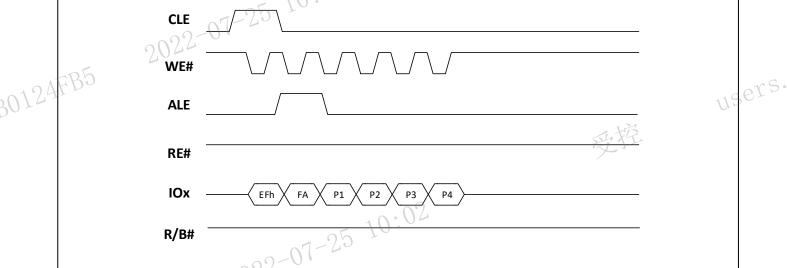


### 10.6.3 Set Feature (EFh)

The Set Feature command is to change the power-on default feature set. After sending the Set Feature command and following register address and then input the P1-P4 parameter data to change the feature set. Once sending the EFh command, the NAND device will remain in the Set Feature mode until next valid command is sent. The Set Feature command is completed instantly, and the R/B# pin will not change to low.

**CLE** 

Figure 20 Set Feature Sequence



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### 10.7 OTP Operation

The OTP area has 62 pages (62 x 2,112-byte). It is a non-erasable and one-time programmable area, which is default to "1" and allows whole page or partial page program to be "0". Once the OTP protection mode is set, the OTP area becomes read-only and cannot be programmed again.

The OTP operation is operated by the Set Feature / Get Feature operation to access the OTP Operation Mode and OTP Lock Mode.

To check the NAND device is ready or busy in the OTP operation mode, either checking the R/B# or using the Read Status command to check the status.

To exit the OTP operation or protect mode, it can be done by writing 00h to P1 at feature address 90h.

### 10.7.1 OTP Read / Program Operation

To enter the OTP Operation Mode, it is by using the Set Feature command and followed by the feature address 90h and then input the 01h to P1 and 00h to P2-P4 of sub-Feature Parameter data (see Table 10 Feature Register).

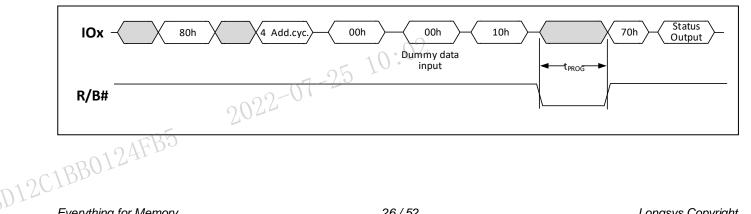
After enter the OTP Operation Mode, the OTP area can be read or programmed like non-OTP area. The users. address of OTP is located on the 02h-3Fh of page address.

### 10.7.2 OTP Lock Operation

To prevent the further OTP data to be changed, the OTP lock operation is necessary. To enter the OTP Lock Mode, it can be done by using the Set Feature command and followed by the feature address 90h and then input the 03h to P1 and 00h to P2-P4 of sub-Feature Parameter data (see Table 10 Feature Register). And then the normal Page Program command with the address 00h before the 10h command is required.

The OTP lock operation is operated on the whole OTP area instead of individual OTP page. Once the OTP protection mode is set, the OTP area can NOT be programmed or unprotected again.

Figure 21 OTP Lock Operation Sequence





### 10.8 Block Protection

The block protect operation can protect the whole chip or selected blocks from erasing or programming. When program or erase attempt at a protected block is happened, the R/B# keeps low for the time of t<sub>PBSY</sub>, and the Status Read command may get the 41h result.

At power-on, all the blocks are default to be un-protected. The Set Feature command with feature address A0h followed by the destined protection bits with data "1" is necessary to protect those selected blocks. After the selected blocks are protected, those protected blocks can be un-protected again by reset Block Protection Bit to "0" if required.

The "solid-protection" feature can be set by writing the Set Feature command with feature address A0h and the "SP" solid protection bit as "1" (see Table 10 Feature Register), after that, the selected block is solid-protected and cannot be up-protected until next power cycle.

**Table 11 Block Protection Bits** 

COIIC	solid protected and calmot be up protected until next power cycle.								
	0-07	-25	)		Table 11	Block Protection Bits			
204	H DDG	DDG	DD4	DDO	Protected	Protected Page	Protected	Protected	
ТВ	BP3	BP2	BP1	BP0	Block(s)	Address PA[15:0]	Density	Portion	
Х	0	0	0	0	NONE	NONE	NONE	NONE	0121
0	0	0	0	1	1022 & 1023	FF80h - FFFFh	256KB	Upper 1/512	8017
0	0	0	1	0	1020 thru 1023	FF00h - FFFFh	512KB	Upper 1/256	
0	0	0	1	1	1016 thru 1023	FE00h - FFFFh	1MB ~S	Upper 1/128	
0	0	1	0	0	1008 thru 1023	FC00h - FFFFh	2MB	Upper 1/64	
0	0	1	0	1	992 thru 1023	F800h - FFFFh	4MB	Upper 1/32	
0	0	1	1	0	960 thru 1023	F000h - FFFFh	8MB	Upper 1/16	
0	0	1	1	1	896 thru 1023	E000h - FFFFh	16MB	Upper 1/8	
0	1	0	0	0	768 thru 1023	C000h - FFFFh	32MB	Upper 1/4	
0	1	0	0	1	512 thru 1023	8000h - FFFFh	64MB	Upper 1/2	
1	0	0	00-	01	0 & 1	0000h – 007Fh	256KB	Lower 1/512	
1	0	0	1	0	0 thru 3	0000h - 00FFh	512KB	Lower 1/256	
153	0	0	1	1	0 thru 7	0000h - 01FFh	1MB	Lower 1/128	105.
1	0	1	0	0	0 thru 15	0000h - 03FFh	2MB	Lower 1/64	ers.
1	0	1	0	1	0 thru 31	0000h - 07FFh	4MB	Lower 1/32	
1	0	1	1	0	0 thru 63	0000h - 0FFFh	8MB	Lower 1/16	
1	0	1	1	1	0 thru 127	0000h - 1FFFh	16MB	Lower 1/8	
1	1	0	0	0	0 thru 255	0000h - 3FFFh	32MB	Lower 1/4	
1	1	0	0	1	0 thru 511	0000h - 7FFFh	64MB	Lower 1/2	
Х	1	0	1	Х	0 thru 1023	0000h - FFFFh	128MB	ALL	
Х	1	1	Х	Х	0 thru 1023	0000h - FFFFh	128MB	ALL	

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### **10.9 Write Protect**

WP# pin can enable or disable program and erase commands preventing or allowing program and erase operations. Figure 22 to Figure 27 shows the enabling or disabling timing with WP# setup time (tww) that is from rising or falling edge of WP# to latch the first commands. After first command is latched, WP# pin must not toggle until the command operation is complete and the device is in the ready state. (Status users. A81 Register Bit6 (IO6) equal 1).

Figure 22 Erase Enable

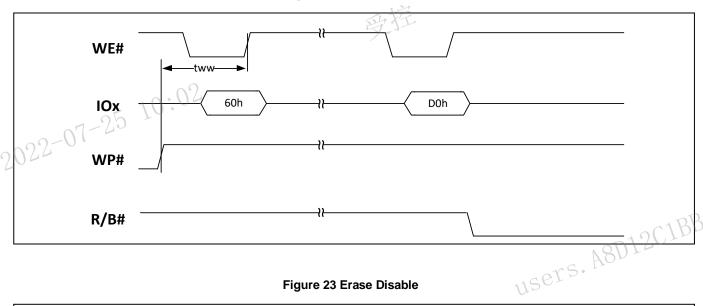
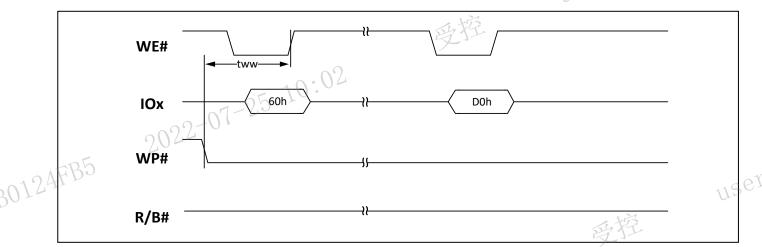


Figure 23 Erase Disable



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Figure 24 Program Enable

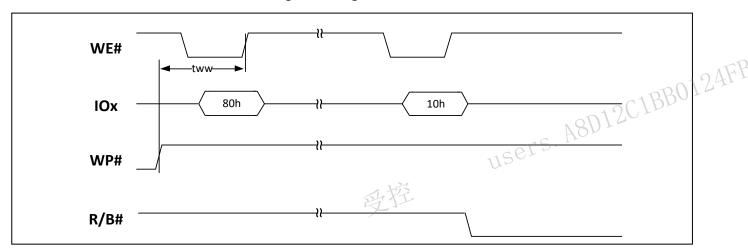


Figure 25 Program Disable

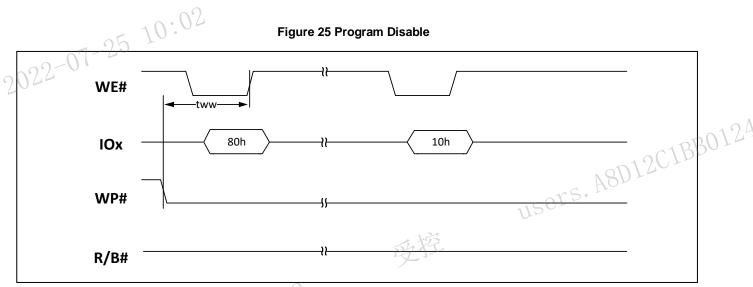
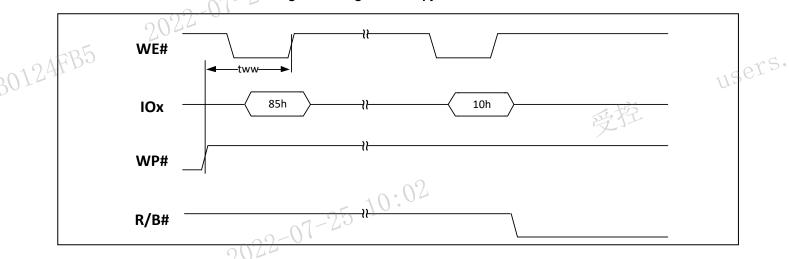


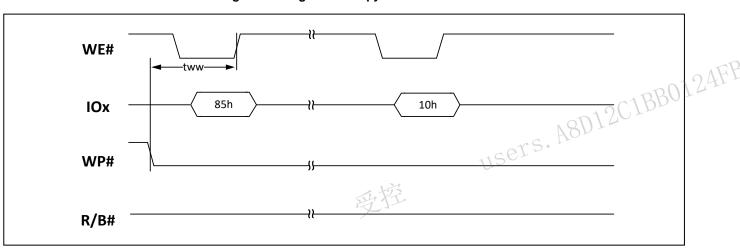
Figure 26 Program for Copy-Back Enable



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### Figure 27 Program for Copy-Back Disable



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users. A8D12C1BB012A

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2022-07-25 10:02

users.

受控

2022-07-25 10:02

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USET



### **Software Algorithm**

### 11.1 Initial Invalid Block(s)

30124FB Initial invalid blocks are defined as blocks that contain one or more initial invalid bits whose reliability is not guaranteed. Devices with initial invalid block(s) have the same quality level as devices with all valid blocks and have the same electrical characteristics. An initial invalid block(s) does not affect the performance of valid block(s). The system design must be able to mask out the initial invalid block(s) via address mapping. The 1st block, which is placed on 00h block address, is guaranteed to be a valid block at the time of shipment.

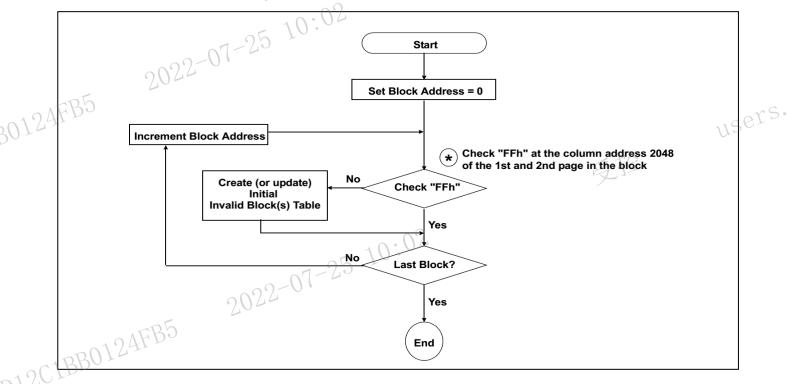
**Table 12 Valid Block Number** 

Parameter	Symbol	Min	Max	Unit
Valid block number	N <sub>VB</sub>	1004	1024	Blocks

### 11.2 Identifying Initial Invalid Block(s)

All device locations are erased (FFh) except locations where the initial invalid block(s) information is written prior to shipping. All initial invalid blocks are marked with non-FFh at the first byte of spare area on the 1st or 2nd page. Since the initial invalid block information is also erasable in most cases, it is impossible to recover the information once it has been erased. Therefore, the system must be able to recognize the initial invalid block(s) based on the original initial invalid block information and create the initial invalid block table via the suggested flow (Figure 28). Any intentional erasure of the original initial invalid block information is prohibited.

Figure 28 Flow to Create Initial Invalid Block Table



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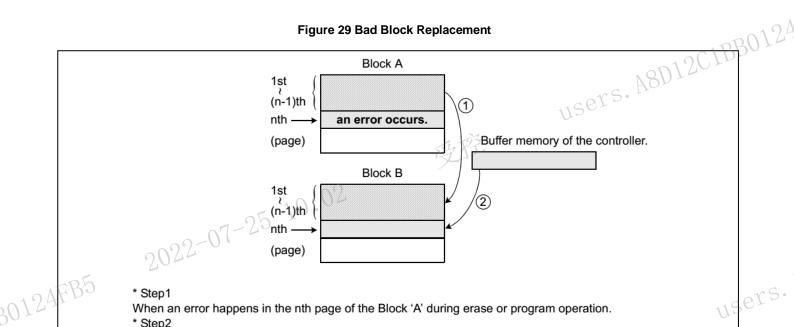
### 11.3 Error in Operation

Within its life time, additional invalid blocks may develop with NAND Flash memory. The following possible failure modes should be considered to implement a highly reliable system. In the case of status read failure after erase or program, block replacement should be done. Because program status fail during a page program does not affect the data of the other pages in the same block, block replacement can be executed with a page-sized buffer by finding an erased empty block and reprogramming the current target data and copying the rest of the replaced block. In case of Read, ECC must be employed. To improve the efficiency of memory space, it is recommended that the read or verification failure due to single bit error be reclaimed by ECC without any block replacement. The said additional block failure rate does not include those reclaimed blocks.

**Table 13 Failure Modes** 

Operation	Detection and recommended procedure					
Erase	Status read after erase → Block Replacement					
Program	Status read after program → Block Replacement					
Read	Verify ECC → ECC correction					

**Figure 29 Bad Block Replacement** 



\* Step1

When an error happens in the nth page of the Block 'A' during erase or program operation.

Copy the data in the 1st ~ (n-1)th page to the same location of another free block. (Block 'B')

\* Step3

Then, copy the nth page data of the Block 'A' in the buffer memory to the nth page of the Block 'B'.

\* Step4

Do not erase or program to Block 'A' by creating an 'invalid block' table or other appropriate scheme.

### 11.4 Addressing for Program Operation

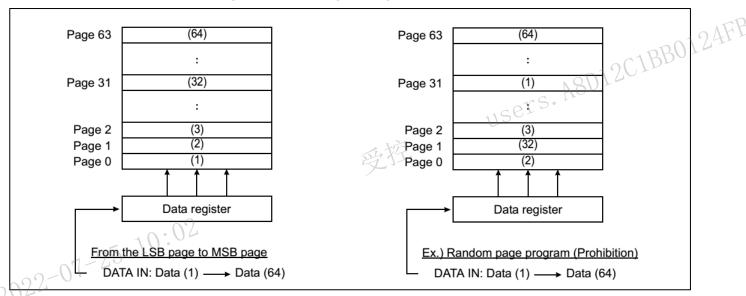
Within a block, the pages must be programmed consecutively from the LSB(least significant bit) page of the block to the MSB(most significant bit) pages of the block. The LSB page is defined as the start page among the pages to be programmed, does not need to be page 0 in the block. Random page address

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programming is prohibited.

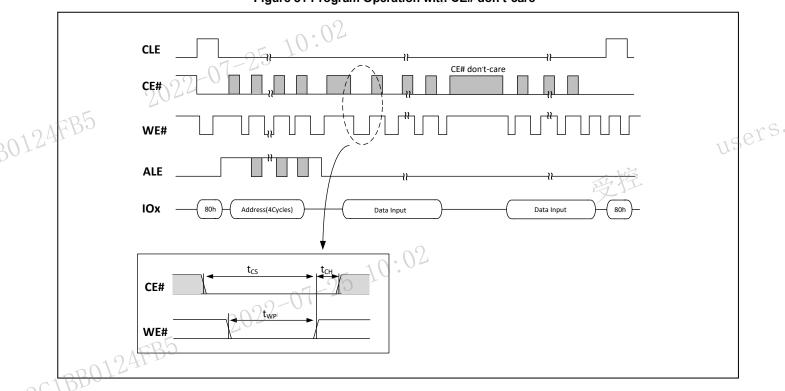
Figure 30 Addressing for Program Operation



### 11.5 System Interface Using CE# Don't-Care

For an easier system interface, CE# may be inactive during the data-loading or serial access as shown below. The internal 2,112 byte data registers are utilized as separate buffers for this operation and the system design gets more flexible. In addition, for voice or audio applications which use slow cycle time on the order of  $\mu$ -seconds, de-activating CE# during the data-loading and serial access would provide significant savings in power consumption.

Figure 31 Program Operation with CE# don't-care



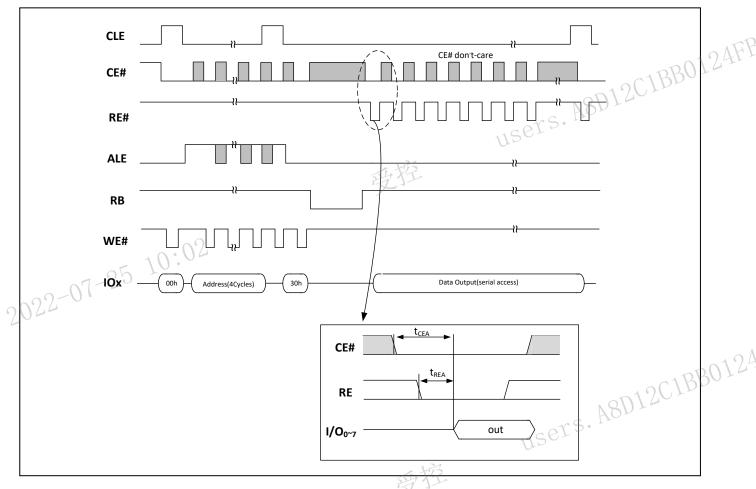
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Figure 32 Read Operation with CE# don't-care



2022-07-25 10:02

30124FB5

users.

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2022-07-25 10:02

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### **Electrical Characteristics**

### 12.1 Absolute Maximum Ratings

Table 14 Absolute Maximum Rating

2.1 Absolute Maximum Ratings			C1BB01
Table 14 Absolute M	aximum Rating	219	CIRPO
Parameters	Symbol	Range	Unit
Supply Voltage	Vcc	-0.6 to +2.5	V
Voltage Applied to Any Pin	V <sub>IO</sub>	-0.6 to V <sub>CC</sub> +0.4	V
Temperature under Bias	T <sub>BIAS</sub>	-40 to +125	°C
Storage Temperature	T <sub>STG</sub>	-65 to +150	°C
Short circuit output current, I/Os	los	5	mA

### Note:

- (1) Minimum DC voltage is -0.6V on input/output pins. During transitions, this level may undershoot to -2.0V for periods <30ns.Maximum DC voltage on input/output pins is VCC+0.3V which, during transitions, may overshoot to VCC+2.0V for periods <20ns.
- (2) Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be users. A8D12C1BB012A restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### 12.2 Operating Ranges

**Table 15 Operating Ranges** 

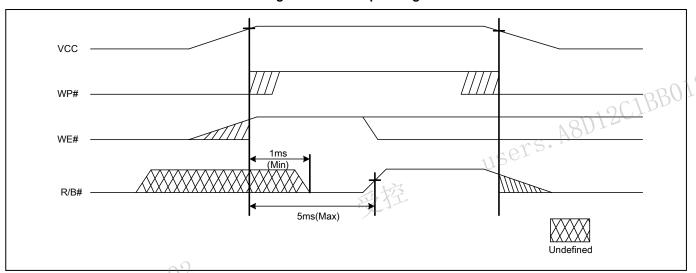
Parameters	Symbol	Conditions	Min	Max	Unit
Supply Voltage	Vcc		1.7	1.95	V
Ambient Temperature	10:00	Industrial	-40	+85	°C
Ambient Temperature	) M	Industrial plus	-40	+105	°C

### 12.3 Power-up Timing

users. The device is designed to offer protection from any involuntary program/erase during power-transitions. An internal voltage detector disables all functions whenever V<sub>CC</sub> is below about 1.1V. WP# pin provides hardware protection and is recommended to be kept at V<sub>IL</sub> during power-up and power down. A recovery time of minimum 1ms is required before internal circuit gets ready for any command sequences as 2022-07-25 10:02 shown in Figure 33.



### Figure 33 Power-up Timing



### 12.4 Pin Capacitance

**Table 16 Pin Capacitance** 

Parameters	Symbol	Min	Max	Unit
Input / Output Capacitance	C <sub>IO</sub>		8	pF D1
Input Capacitance	C <sub>IN</sub>		8	2 pF
Note:			Y8n:	
(1) Test conditions: TA=25°C, F=1MHz, $V_{IN}$ =0V, $V_{CC}$ =1.8V		115	ers.	
(2) These parameters are characterized only.		OLD		

### Note:

- (1) Test conditions: TA=25°C, F=1MHz, V<sub>IN</sub>=0V, V<sub>CC</sub>=1.8V
- (2) These parameters are characterized only.

### 12.5 DC Electrical Characteristics

**Table 17 DC Electrical Characteristics** 

Donomotoro O d	7-20	Conditions		SPEC <sup>(1)</sup>	Unit		
Parameters 22	<b>○</b> Symbol	Conditions	Min	Тур	Тур Мах		
Standby Current(CMOS)	I <sub>SB</sub>	CE# = $V_{CC}$ - 0.2V, All Input Pin = 0V/ $V_{CC}$ , IO7 - IO0 = 0V/ $V_{CC}$		10	50	μA	ers.
Page Read Current	I <sub>CC1</sub>			10	25	mA	
Program Current	I <sub>CC2</sub>			15,	25	mA	
Erase Current	I <sub>CC3</sub>			15	25	mA	
Input Leakage Current	ILI	$V_{IN} = 0$ to $V_{CC}(max)$			±10	μA	
Output Leakage Current	I <sub>LO</sub>	V <sub>OUT</sub> = 0 to V <sub>CC</sub> (max)			±10	μA	
Output Low Current (R/B#)	I <sub>OL(R/B#)</sub>	V <sub>OL</sub> = 0.2V	3	4		mA	
Input Low Voltage	V <sub>IL</sub>	7.5	-0.3		0.2V <sub>CC</sub>	V	
Input High Voltage V <sub>IH</sub>		-0.1	0.8V <sub>CC</sub>		V <sub>CC</sub> +0.3	V	
Output Low Voltage		I <sub>OL</sub> = 100μA			0.2	V	
Output High Voltage	V <sub>OH</sub>	Ι <sub>ΟΗ</sub> = -100μΑ	V <sub>CC</sub> -0.2			V	

Note:

<sup>(1)</sup> Applicable over recommended operating range from: T<sub>A</sub> = -40°C to +85°C, VCC= 1.7V to 1.95V, unless otherwise noted.



### 12.6 AC Measurement Conditions

**Table 18 AC Measurement Conditions** 

Table 18 AC Measuren	nent Condition	ns		01
Parameters	Symbol	Min	Max	Unit
Load Capacitance	C <sub>L</sub>		30	pF
Input Rise Time	t <sub>R</sub>	- 01	S . 5	ns
Input Fall Time	t <sub>F</sub>	use	5	ns
Input Pulse Voltages	V <sub>IN</sub>	0 to V <sub>CC</sub>		V
Input Timing Reference Voltages	之1N	0.5V <sub>CC</sub>		V
Output Timing Reference Voltages	OUT	0.5V <sub>CC</sub>		V

# 12.7 AC Electrical Characteristics

Table 19 AC Electrical Characteristics for Command, Address and Data Input

10000 10710 = 10000 0100 0100000 0100000 0100000 0100000 0100000 0100000 01000000					
Parameters	O:h al		11.24		
	Symbol	Min	Тур	Max	Unit
Address to Data Loading Time	t <sub>ADL</sub> <sup>(2)</sup>	70			ns B
ALE Setup Time	t <sub>ALS</sub> (3)	12		1801	ns
ALE Hold Time	t <sub>ALH</sub>	5	ar S	. Ho.	ns
CE# Setup Time	t <sub>CS</sub> <sup>(3)</sup>	20	USEL		ns
CE# Hold Time	tсн	5			ns
CLE Setup Time	t <sub>CLS</sub> (3)	12			ns
CLE Hold Time	tclh	5			ns
Data Setup Time	t <sub>DS</sub> <sup>(3)</sup>	12			ns
Data Hold Time	t <sub>DH</sub>	5			ns
Write Cycle Time	twc	25			ns
WE# Pulse Width	t <sub>WP</sub>	12			ns
WE# High Hold Time	t <sub>WH</sub>	10			ns
WP# Setup Time (to WE# high)	t <sub>ww</sub>	100			ns

#### Note:

- (1) Applicable over recommended operating range from:  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ , VCC= 1.7V to 1.95V, unless otherwise noted.
- (2) t<sub>ADL</sub> is the time from the WE# rising edge of final address cycle to the WE# rising edge of first data cycle.
- (3) The transition of the corresponding control pins must occur only once while WE# is held low.

**Table 20 AC Electrical Characteristics for Operation** 

Povemetors 07-25	Cumbal		Unit		
Parameters	Symbol	Min	Тур	Max	Onit
ALE to RE# Delay	t <sub>AR</sub>	10		-	ns
CE# Access Time	t <sub>CEA</sub>	-		25	ns
CE# High to Output Hi-Z	t <sub>CHZ</sub>	-		50	ns



Parameters	O-mah al	SPEC <sup>(1)</sup>			l lade	
	Symbol	Min	Тур	Max	Unit	
CE# High to ALE or CLE Don't Care	t <sub>CSD</sub>	0		-	ns	
CLE to RE# Delay	t <sub>CLR</sub>	10		-	ns	151
Data Hold Time after CE# Disable	t <sub>COH</sub>	15		-	ns	1241
Output Hi-Z to RE# Low	t <sub>IR</sub>	0		-190	ns	
Read Cycle Time	t <sub>RC</sub>	25	A	8117	ns	
RE# Access Time	t <sub>REA</sub>		rs.	22	ns	
RE# High Hold Time	t <sub>REH</sub>	10		-	ns	
RE# High to Output Hold (EDO)	t <sub>RHOH</sub>	15		-	ns	
RE# High to WE# Low	t <sub>RHW</sub>	100		-	ns	
RE# High to Output Hi-Z	t <sub>RHZ</sub>	-		100	ns	=
RE# Low to Output Hold (EDO)	t <sub>RLOH</sub>	5		-	ns	=
RE# Pulse Width	t <sub>RP</sub>	12		-	ns	=
Ready to RE# Low	t <sub>RR</sub>	20		-	ns	
WE# High to Busy	t <sub>WB</sub>	-		100	ns	1
WE# High to RE# Lo	t <sub>WHR</sub>	60			ns	1
Device reset time (Read/Program/Erase)	t <sub>RST</sub> <sup>(2)</sup>			5/20/200	μS	1

- (1) Applicable over recommended operating range from: T<sub>A</sub> = -40°C to +85°C, VCC= 1.7V to 1.95V, unless otherwise noted.
   (2) If Reset command (FFh) is written at Ready state, the device is react instant.
- users.

# 12.8 Read / Program / Erase Characteristics

Table 21 Read / Program / Erase Characteristics

Parameters 10.02	Symbol	SPEC <sup>(1)</sup>			Unit	
raiantelets 1	Symbol	Min	Тур	Max	Offic	
Data Transfer from Cell to Page buffer	t <sub>RD</sub>			25	μS	
Program Time	t <sub>PROG</sub> (2)		350	700	μS	
Block Erase Time	t <sub>ERS</sub>		2	10	ms	
The busy time for program/erase at protected block	t <sub>PBSY</sub>			3	μS	
The busy time for Set Feature / Get Feature	t <sub>FEAT</sub>		码	全1	μS	
Number of Partial Program Cycles	NOP		7	4	cycles	

- (1) Applicable over recommended operating range from:  $T_A = -40$  °C to +85 °C, VCC= 1.7V to 1.95V, unless otherwise noted.
- Typical program time is defined as the time within which more than 50% of the whole pages are programmed at 1.8V and 2022-07-25 25°C.

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# **Timing Diagram**

**Figure 34 Command Input Cycle** 

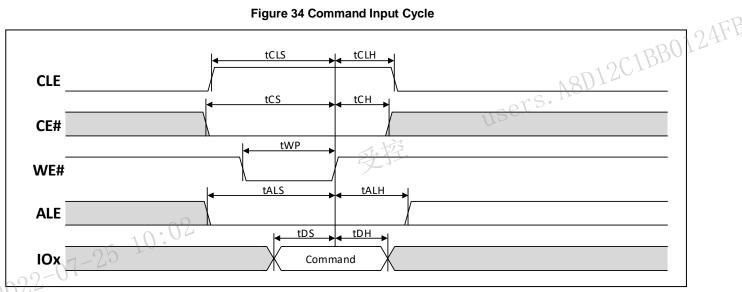
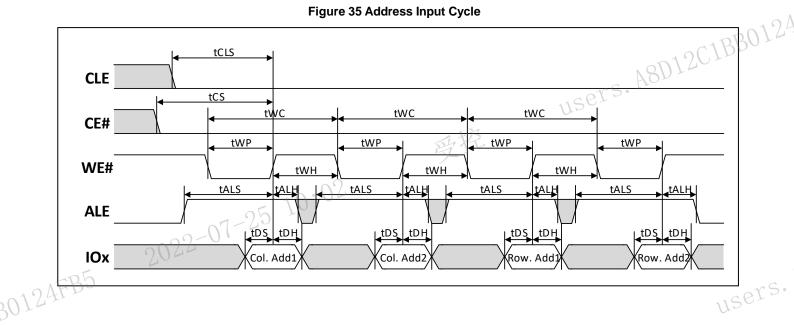


Figure 35 Address Input Cycle



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Figure 36 Data Input Cycle

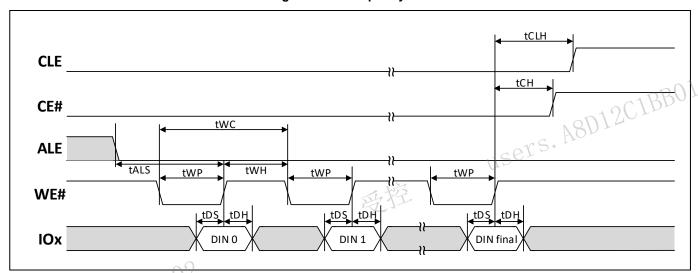


Figure 37 Serial Access Cycle after Read (CLE = L, ALE = L, WE# = H)

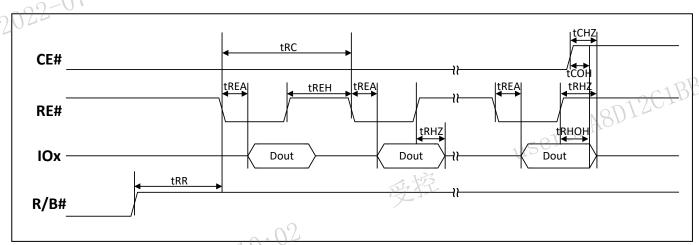
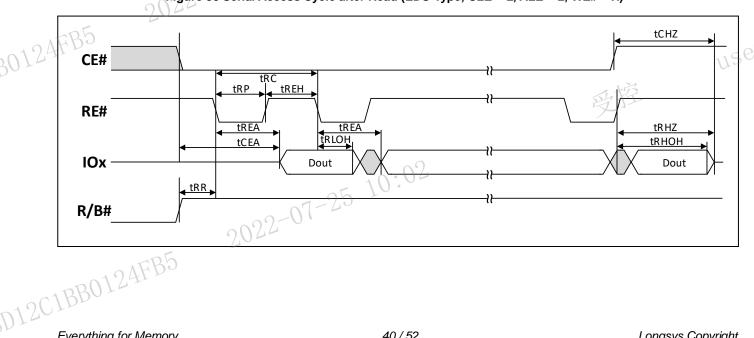


Figure 38 Serial Access Cycle after Read (EDO Type, CLE = L, ALE = L, WE# = H)



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#### Figure 39 Read Status

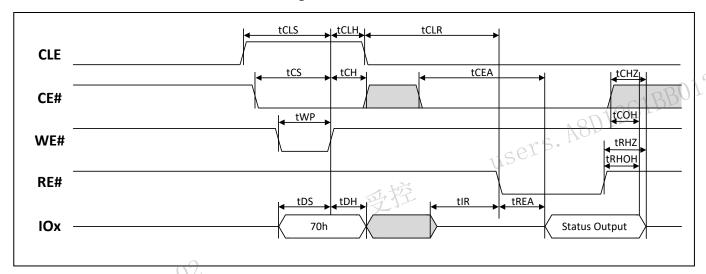
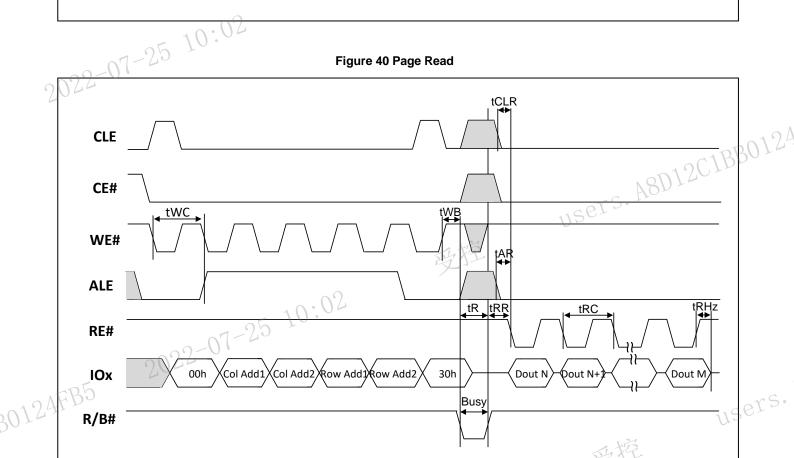


Figure 40 Page Read

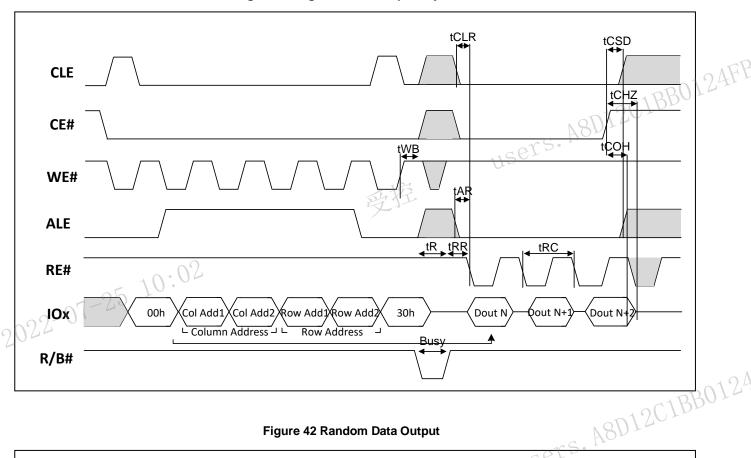


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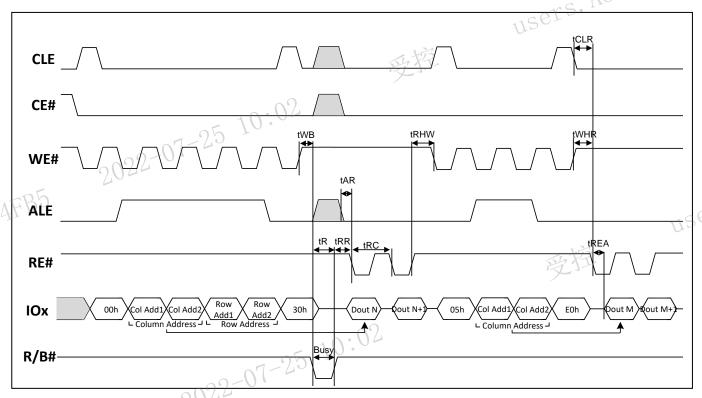
D12C1BB0124FB5 41/52 Everything for Memory Longsys Copyright



Figure 41 Page Read Intercepted by CE#



**Figure 42 Random Data Output** 

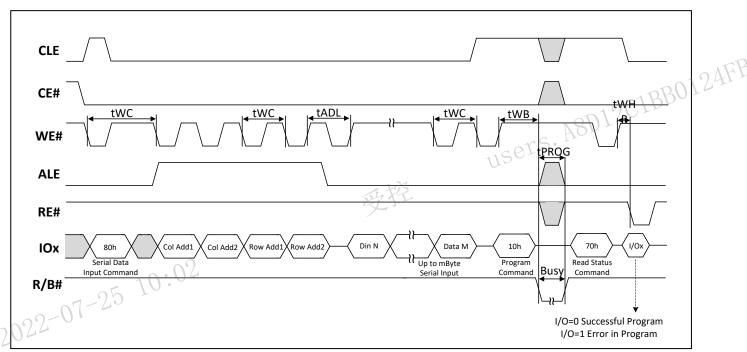


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#### Figure 43 Page Program



users. A8D12C1BB012A

受控

2022-07-25 10:02

users.

受控

2022-07-25 10:02

D12C1BB0124FB5

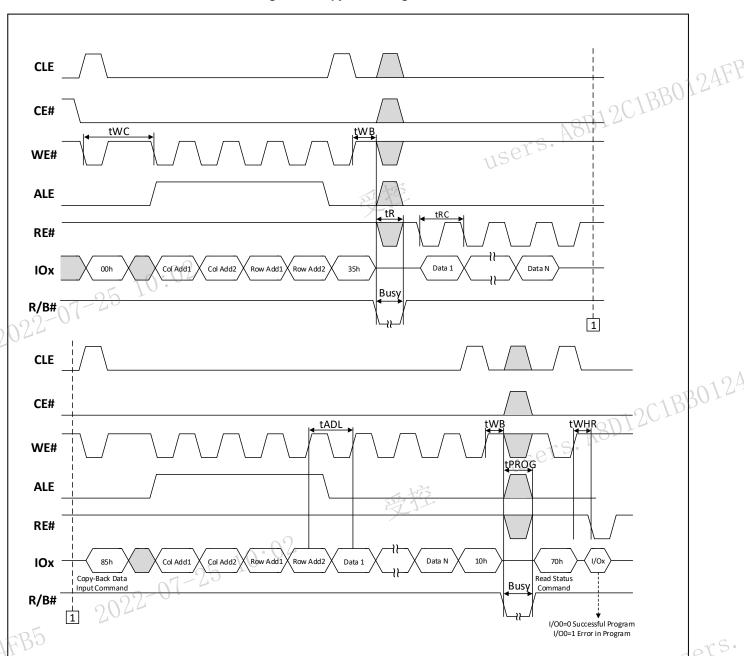
30124FB5

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USE



Figure 44 Copy-Back Program



受控

2022-07-25 10:02

D12C1BB0124FB5

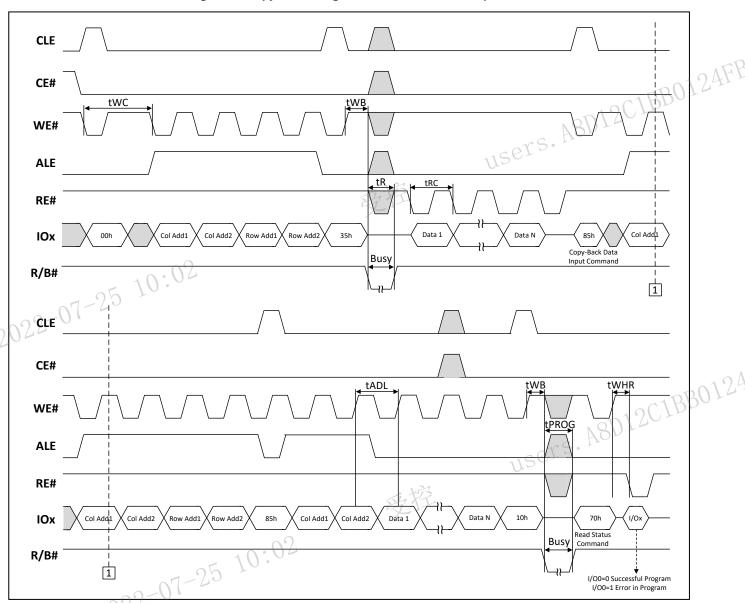
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44/52



Figure 45 Copy-Back Program with Random Data Input



30124FB5

users.

受控

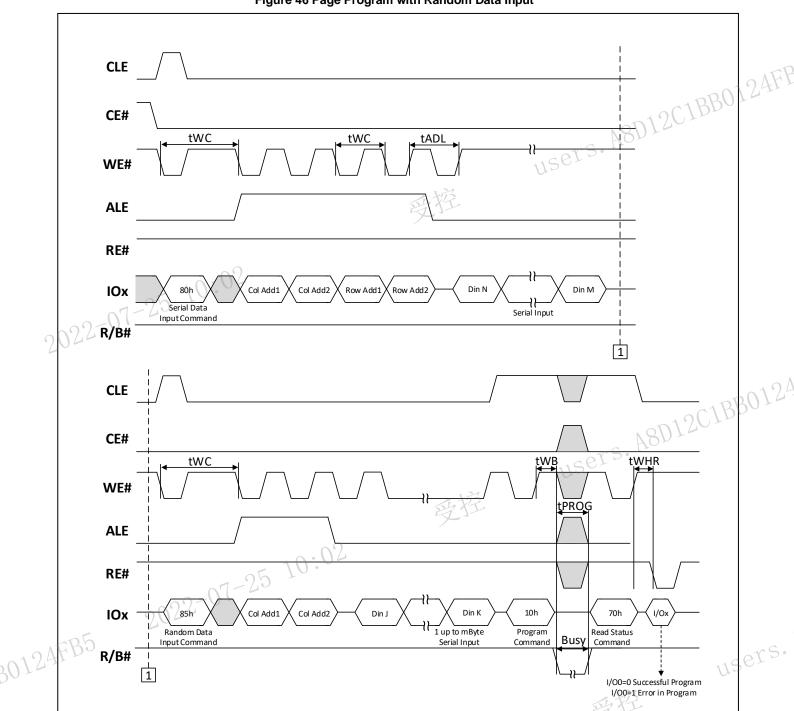
2022-07-25 10:02

D12C1BB0124FB5

USET



Figure 46 Page Program with Random Data Input



2022-07-25 10:02

D12C1BB0124FB5

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### Figure 47 Block Erase

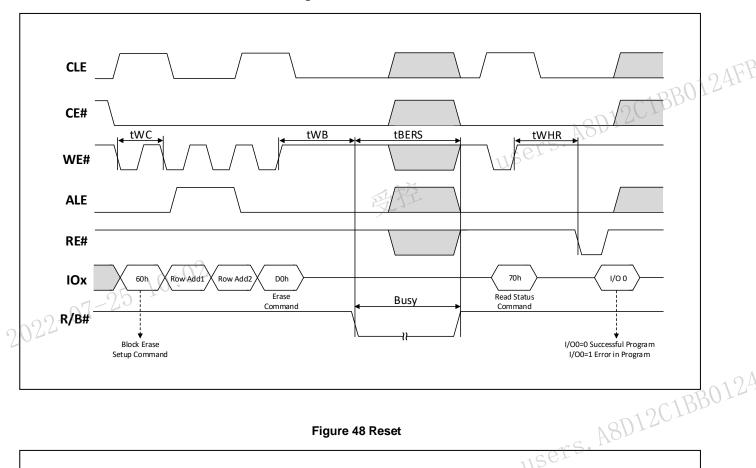
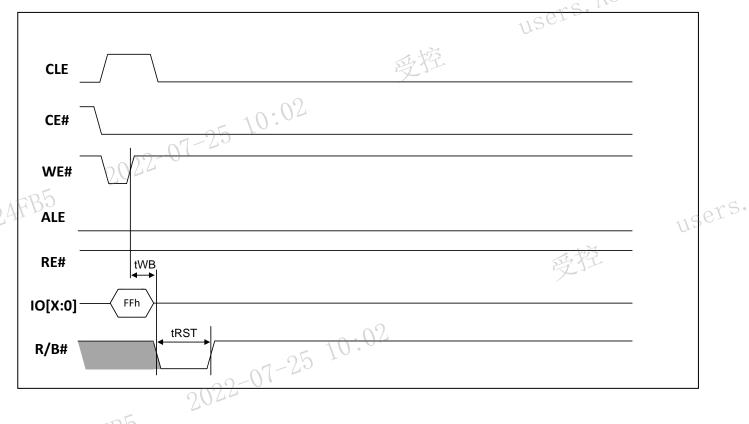


Figure 48 Reset

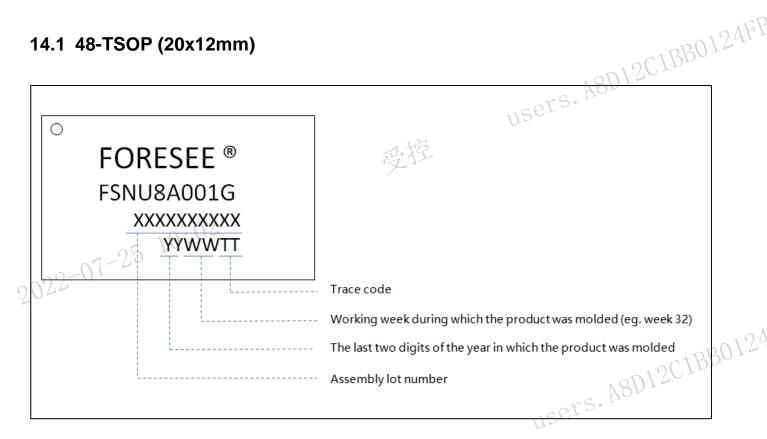


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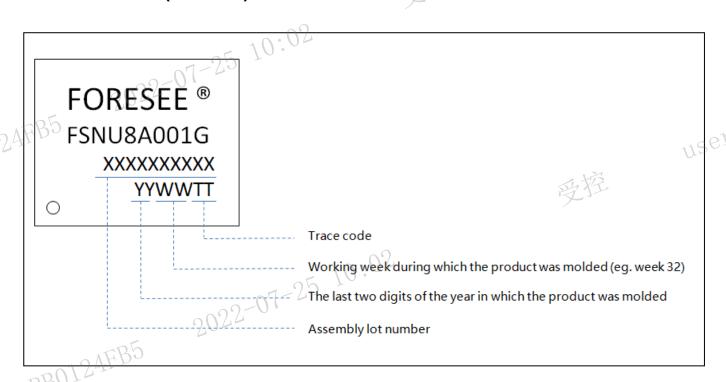


# **Part Marking Scheme**

## 14.1 48-TSOP (20x12mm)



# 14.2 63-TFBGA (11x9mm)

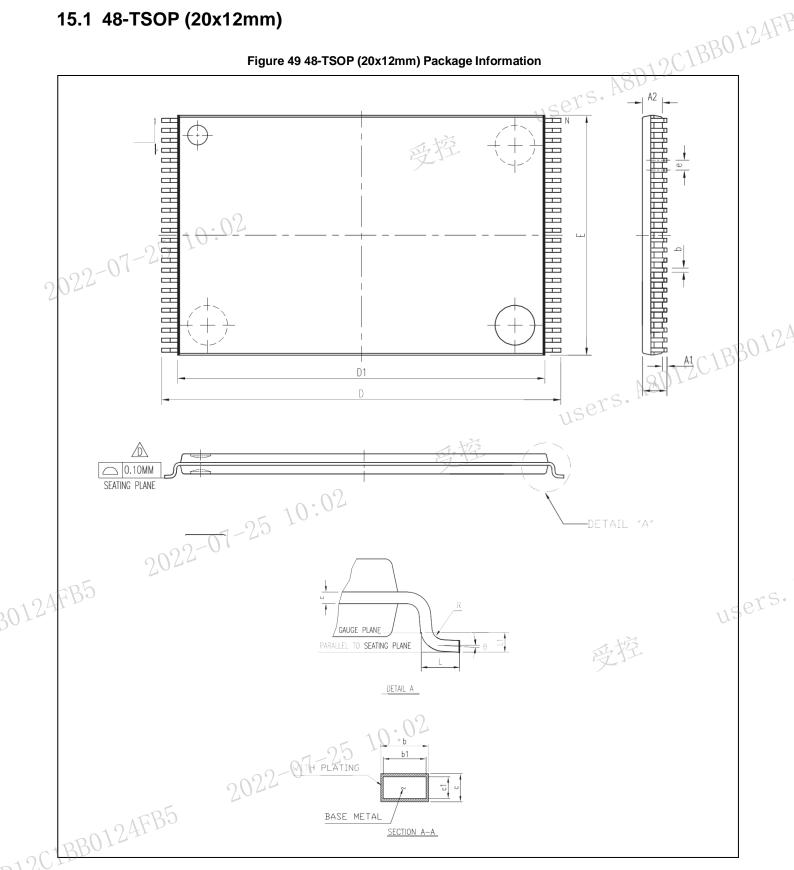




# **Packaging Information**

# 15.1 48-TSOP (20x12mm)

Figure 49 48-TSOP (20x12mm) Package Information



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**Table 22 48-TSOP Package Information** 

SYMBOL	Min. (mm)	Nom. (mm)	Max. (mm)	
Α			1.20	
A1	0.05		0.15	
A2	0.95	1.00	1.05	(24F
D	19.80	20.00	20.20 1 880	1
D1	18.30	18.40	18.50	
E	11.90	12.00	rS. 12.10	
b	0.17	0.22	0.27	
b1	0.17	0.20	0.23	
С	0.10	71-	0.21	
c1	0.10		0.16	
е		0.50 BASIC		
L , (	0.50	0.60	0.70	
L1)5	0.24	0.25	0.26	
00-01R	0.08		0.35	
022	0°	5°	8°	

users. A8D12C1BB012A

受控

2022-07-25 10:02

users.

受控

2022-07-25 10:02

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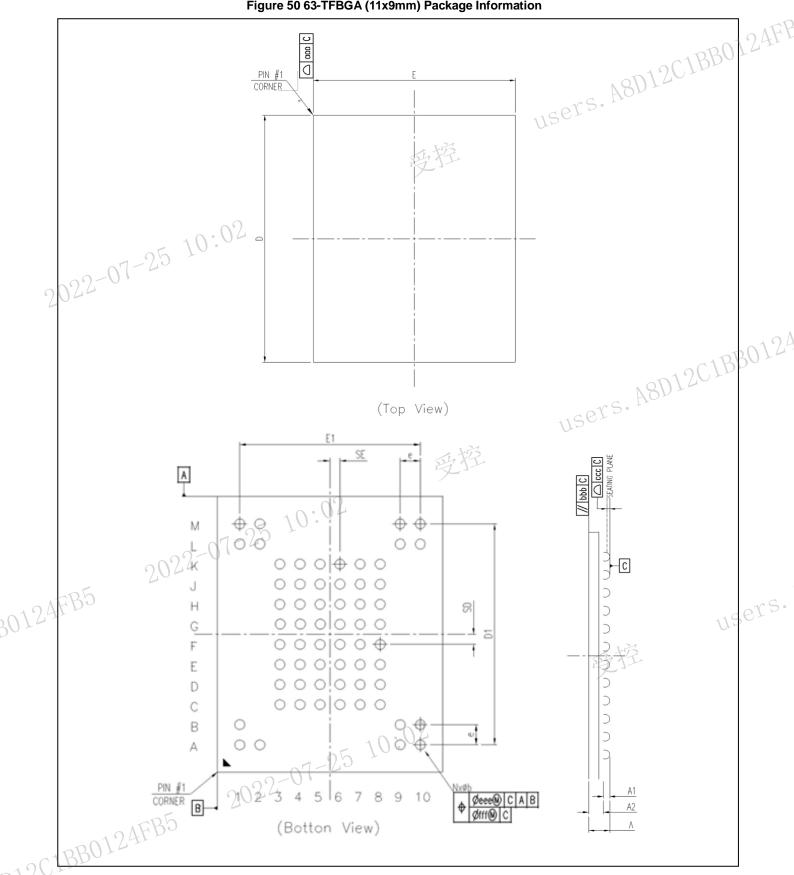
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# 15.2 63-TFBGA (11x9mm)

Figure 50 63-TFBGA (11x9mm) Package Information



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Table 23 63-TFBGA (11x9mm) Package Information

SYMBOL	Min. (mm)	Nom. (mm)	Max. (mm)	
Α			1.00	
A1	0.25		0.31	0124
A2		0.65	-oc1BP	2012
b	0.35	0.40	0.45	
D	10.90	11.00	rS. 11.10	
D1		8.80 BASIC 11.5	,02	
SD		0.40 BASIC		
E	8.90	9.00	9.10	
E1		7.20 BASIC	-	
SE		0.40 BASIC		
e (	)2	0.80 BASIC		
aaa		0.10		
bbb		0.20		
CCC		0.12		
eee		0.15		
fff		0.08		01
			users. A8D12C1	BBOI

受控

2022-07-25 10:02

users.

受控

2022-07-25 10:02

D12C1BB0124FB5

30124FB5

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